

DOCKET NO: 295408US40PCT

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :  
DAISUKE HIROKANE : ATTN: APPLICATION DIVISION  
SERIAL NO: NEW U.S. PCT APPLICATION :  
(BASED ON PCT/JP05/04705)  
FILED: HERewith :  
FOR: EPOXY RESIN COMPOSITION FOR :  
THE ENCAPSULATION OF  
SEMICONDUCTORS AND  
SEMICONDUCTOR DEVICES

PRELIMINARY AMENDMENT

COMMISSIONER FOR PATENTS  
ALEXANDRIA, VIRGINIA 22313

SIR:

Prior to examination on the merits, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 4 of this paper.